

# NS5S1153

## USB 2.0 High Speed and Audio Switch with Negative Swing Capability

The NS5S1153 is a DPDT switch for combined true-ground audio and USB 2.0 high speed data applications. It allows portable systems to use a single port to pass either USB data or audio signals from an external headset; headset; the 2 channels being compliant to USB 2.0, USB 1.1 and USB 1.0.

The switch is capable of passing signals with negative voltages as low as 2 V below ground. The device features shunt resistors on the audio ports. These resistors are switched in when the audio channel is off and provide a safe path to ground for any charge that may build up on the audio lines. This reduces Pop & Click noise in the audio system. The NS5S1153 is also equipped with VBUS detection circuitry to immediately switch to USB mode in the event that a voltage is detected on VBUS.

The NS5S1153 is housed in a space saving, ultra low profile 1.4 x 1.8 x 0.5 mm 10 pin UQFN package.

### Features

- 2:1 High Speed Switch
- USB 2.0, USB 1.1 & USB 1.0 Capable on all channels
- High Bandwidth of 820 MHz on D+/D-
- Capable of Passing Negative Swing Signals Down to -2 V on R/L Channel
- 1.8 V Compatible Control Pin & VBUS Detection Circuitry for Automatic Switching
- Audio Channel Shunt Resistors for Pop & Click Noise Reduction
- Ultra-Low THD in Audio Mode: 0.01% into 16 Ω Load
- 5.25 V Tolerant Common Pins
- This is a Pb-Free Device

### Typical Applications

- Micro or Mini USB Applications
- Shared High Speed Data or Audio on a Single Connector
- Mobile Phones
- Tablets
- Bar Code Scanners
- Portable Devices

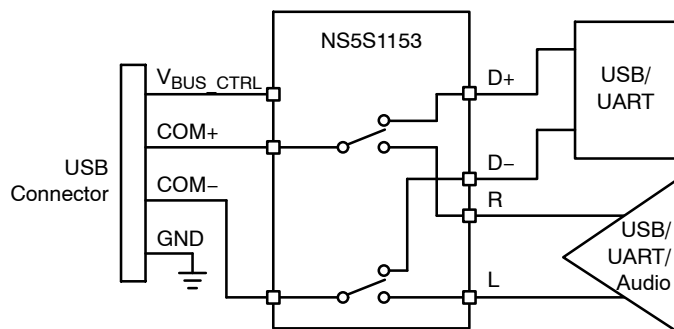


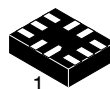
Figure 1. Application Diagram



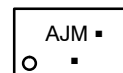
ON Semiconductor®

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### MARKING DIAGRAMS



UQFN10  
CASE 488AT



AJ = Specific Device Code  
M = Date Code  
▪ = Pb-Free Package

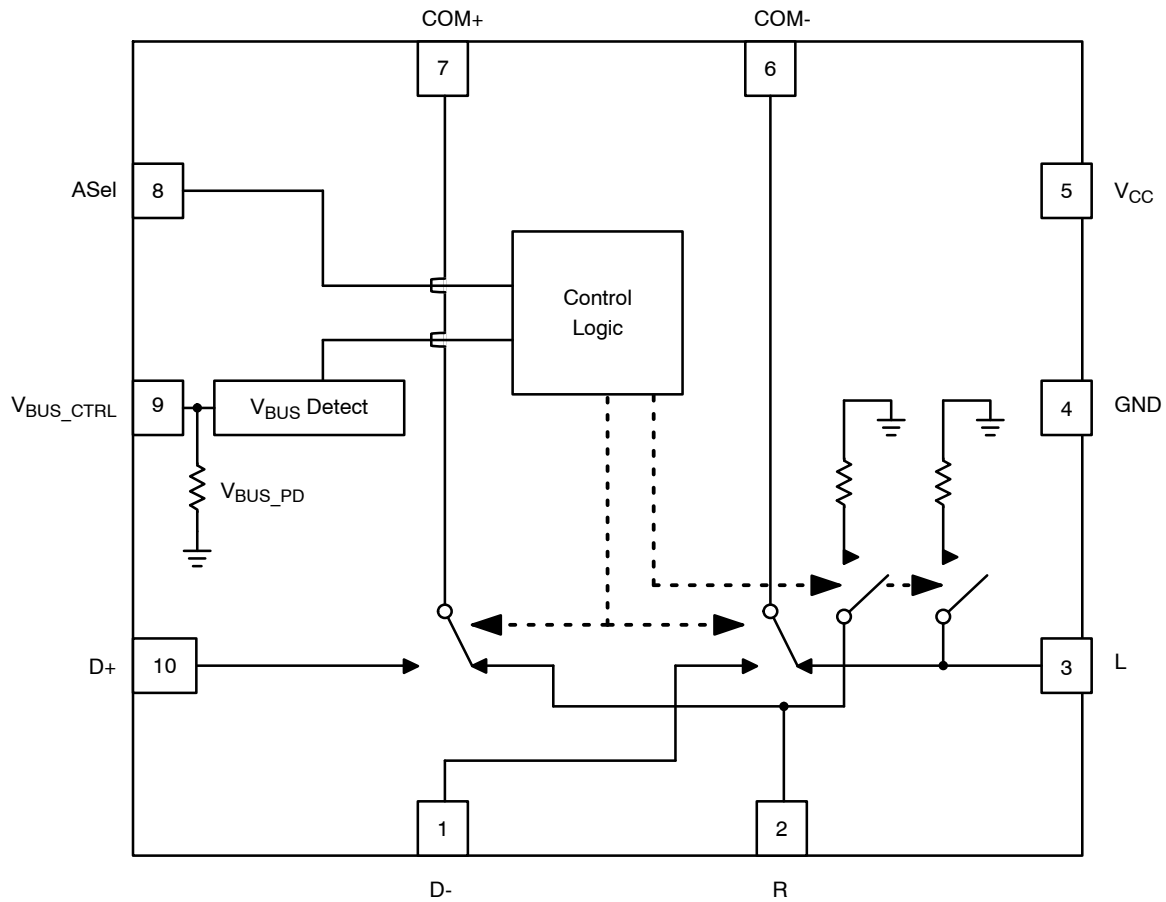
(Note: Microdot may be in either location)

### ORDERING INFORMATION

Device	Package	Shipping†
NS5S1153MUTAG	UQFN10 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# NS5S1153



**Figure 2. Functional Block Diagram**  
(Top View)

## PIN DESCRIPTIONS

Pin #	Name	Direction	Description
1	D-	I/O	Negative Data Line for USB Signals
2	R	I/O	Right Line for Audio Signals
3	L	I/O	Left Line for Audio Signals
4	GND	Power	Ground
5	V <sub>CC</sub>	Power	Power Supply
6	COM-	I/O	Left Audio / Negative Data Common Line
7	COM+	I/O	Right Audio / Positive Data Common Line
8	A <sub>SEL</sub>	Input	Control Input Override Select Line
9	V <sub>BUS_CTRL</sub>	Input	Control Input Select Line from V <sub>BUS</sub>
10	D+	I/O	Positive Data Line for USB Signals

## TRUTH TABLE

A <sub>SEL</sub>	V <sub>BUS</sub>	L, R	D+, D-	L, R SHUNT
Low	Low	ON	OFF	OFF
Low	High	OFF	ON	ON
High	X	ON	OFF	OFF

# NS5S1153

## OPERATING CONDITIONS

### MAXIMUM RATINGS

Symbol	Pins	Parameter	Value	Unit
V <sub>CC</sub>	V <sub>CC</sub>	Positive DC Supply Voltage	-0.5 to +6.0	V
V <sub>BUS</sub>	V <sub>BUS_CTRL</sub>	V <sub>BUS</sub> Control Input Voltage	-0.5 to +6.0	V
V <sub>IS</sub>	D+ to COM+ D- to COM-	Analog Signal Voltage	-0.5 to +6.0	V
	R to COM+ L to COM-		-2.5 to V <sub>CC</sub> + 0.5	
V <sub>IS</sub>	COM+, COM-	DC Signal Voltage Tolerance (<24 hours)	5.25	V
V <sub>IN</sub>	ASel	Control Input Override Voltage	-0.5 to +6.0	V
I <sub>CC</sub>	V <sub>CC</sub>	Positive DC Supply Current	50	mA
T <sub>S</sub>		Storage Temperature	-65 to +150	°C
I <sub>IS_CON</sub>	COM+, COM- R, L, D+, D-	Analog Signal Continuous Current—Closed Switch	± 100	mA
I <sub>IS_PK</sub>	COM+, COM- R, L, D+, D-	Analog Signal Continuous Current 10% Duty Cycle	± 500	mA
I <sub>IN</sub>	ASel	Control Input Override Current	1	mA
	V <sub>BUS_CTRL</sub>	V <sub>BUS</sub> Control Input Current	1	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

### RECOMMENDED OPERATING CONDITIONS

Symbol	Pins	Parameter	Min	Max	Unit
V <sub>CC</sub>	V <sub>CC</sub>	Positive DC Supply Voltage	2.7	5.0	V
V <sub>BUS</sub>	V <sub>BUS_CTRL</sub>	V <sub>BUS</sub> Control Input Voltage	GND	5.25	V
V <sub>IS</sub>	D+ to COM+ D- to COM-	Analog Signal Voltage (Note 1)	GND	V <sub>CC</sub>	V
	R to COM+ L to COM-		-2.0	V <sub>CC</sub>	
V <sub>IN</sub>	ASel	Control Input Override Voltage	GND	V <sub>CC</sub>	V
T <sub>A</sub>		Operating Temperature	-40	+85	°C

Minimum and maximum values are guaranteed through test or design across the Recommended Operating Conditions, where applicable. Typical values are listed for guidance only and are based on the particular conditions listed for section, where applicable. These conditions are valid for all values found in the characteristics tables unless otherwise specified in the test conditions.

1. In USB mode, any signal applied to the off-state audio inputs R, L may not swing below ground or above 1.5 V.

## DC ELECTRICAL CHARACTERISTICS

CONTROL INPUT (Typical: T = 25°C, V<sub>CC</sub> = 3.3 V)

Symbol	Pins	Parameter	Test Conditions	V <sub>CC</sub> (V)	-40°C to +85°C			Unit
					Min	Typ	Max	
V <sub>IH</sub>	A <sub>SEL</sub>	Control Input HIGH Voltage		2.7	1.3	-	-	V
				3.3	1.4	-	-	
				4.2	1.5	-	-	
V <sub>IL</sub>	A <sub>SEL</sub>	Control Input LOW Voltage		2.7	-	-	0.4	V
				3.3	-	-	0.4	
				4.2	-	-	0.4	
I <sub>IN</sub>	A <sub>SEL</sub>	Current Input Leakage Current	0 ≤ V <sub>IS</sub> ≤ V <sub>CC</sub>	4.2	-	-	±50	nA
V <sub>IH</sub>	V <sub>BUS_CTRL</sub>	V <sub>BUS</sub> Control Input HIGH Voltage		2.7	1.9	-	-	V
				3.3	2.2	-	-	
				4.2	2.7	-	-	
V <sub>IL</sub>	V <sub>BUS_CTRL</sub>	V <sub>BUS</sub> Control Input LOW Voltage		2.7	-	-	0.8	V
				3.3	-	-	1.1	
				4.2	-	-	1.6	
I <sub>IN</sub>	V <sub>BUS_CTRL</sub>	V <sub>BUS</sub> Current Input Leakage Current	0 ≤ V <sub>IS</sub> ≤ V <sub>CC</sub>	4.2	-	-	±25	μA

SUPPLY CURRENT AND LEAKAGE (Typical: T = 25°C, V<sub>CC</sub> = 3.3 V)

Symbol	Pins	Parameter	Test Conditions	V <sub>CC</sub> (V)	-40°C to +85°C			Unit
					Min	Typ	Max	
I <sub>NC,NO(OFF)</sub>	D+, D-	OFF State Leakage	V <sub>BUS_CTRL</sub> = 0 V, 4.2 V; V <sub>COM-</sub> , V <sub>COM+</sub> = 0 V, 4.2 V V <sub>D+</sub> , V <sub>D-</sub> = 4.2 V, 0 V or float V <sub>L</sub> , V <sub>R</sub> = float or 4.2 V, 0 V	4.2			±80	nA
I <sub>COM(ON)</sub>	COM-, COM+	ON State Leakage	V <sub>BUS_CTRL</sub> = 0 V, 4.2 V; V <sub>COM-</sub> , V <sub>COM+</sub> = 0 V, 4.2 V V <sub>D+</sub> , V <sub>D-</sub> = 4.2 V, 0 V or float V <sub>L</sub> , V <sub>R</sub> = float or 4.2 V, 0 V	4.2			±100	nA
I <sub>CC</sub>	V <sub>CC</sub>	Quiescent Supply	V <sub>IS</sub> = GND to V <sub>CC</sub> ; I <sub>D</sub> = 0 A	4.2		21	35	μA
I <sub>OFF</sub>	COM-, COM+	Power OFF Leakage	0 ≤ V <sub>IS</sub> ≤ 4.2 V	0			50	μA

USB ON RESISTANCE (Typical: T = 25°C, V<sub>CC</sub> = 3.3 V)

Symbol	Pins	Parameter	Test Conditions	V <sub>CC</sub> (V)	-40°C to +85°C			Unit
					Min	Typ	Max	
R <sub>ON</sub>	D+ to COM+ D- to COM-	On-Resistance	I <sub>ON</sub> = 10 mA V <sub>IS</sub> = 0 V to V <sub>CC</sub>	2.7		3.0	5.5	Ω
				3.3		3.0	4.6	
				4.2		3.0	4.6	
R <sub>FLAT</sub>	D+ to COM+ D- to COM-	On-Resistance Flatness	I <sub>ON</sub> = 10 mA V <sub>IS</sub> = 0 V to V <sub>CC</sub>	2.7		0.08		Ω
				3.3		0.08		
				4.2		0.08		
ΔR <sub>ON</sub>	D+ to COM+ D- to COM-	On-Resistance Matching	I <sub>ON</sub> = 10 mA V <sub>IS</sub> = 0 V to V <sub>CC</sub>	2.7		0.03		Ω
				3.3		0.03		
				4.2		0.03		

AUDIO ON RESISTANCE (Typical: T = 25°C, V<sub>CC</sub> = 3.3 V)

Symbol	Pins	Parameter	Test Conditions	V <sub>CC</sub> (V)	-40°C to +85°C			Unit
					Min	Typ	Max	
R <sub>ON</sub>	R to COM+ L to COM-	On-Resistance	I <sub>ON</sub> = 10 mA V <sub>IS</sub> = -1.5 to 1.5	2.7		3.0	4.6	Ω
				3.3		3.0	4.6	
				4.2		3.0	4.6	
R <sub>FLAT</sub>	R to COM+ L to COM-	On-Resistance Flatness	I <sub>ON</sub> = 10 mA V <sub>IS</sub> = -1.5 to 1.5	2.7		0.11		Ω
				3.3		0.11		
				4.2		0.11		
ΔR <sub>ON</sub>	R to COM+ L to COM-	On-Resistance Matching	I <sub>ON</sub> = 10 mA V <sub>IS</sub> = -0.85 to 0.85	2.7		0.03		Ω
				3.3		0.03		
				4.2		0.03		
R <sub>SH</sub>	L, R	Shunt Resistance (Resistor + Switch)	I <sub>ON</sub> = 10 mA	2.7		118	160	Ω
V <sub>BUS_PD</sub>	V <sub>BUS_CTRL</sub>	V <sub>BUS_CTRL</sub> Pull-down Resistor	I <sub>ON</sub> = 10 mA			530		kΩ

AC ELECTRICAL CHARACTERISTICS

**TIMING/FREQUENCY** (Typical: T = 25°C, V<sub>CC</sub> = 3.3 V, R<sub>L</sub> = 50 Ω, C<sub>L</sub> = 35 pF, f = 1 MHz)

Symbol	Pins	Parameter	Test Conditions	V <sub>CC</sub> (V)	-40°C to +85°C			Unit
					Min	Typ	Max	
t <sub>ON</sub>		Turn-ON Time (Closed to Open) (Figures 8 and 9)		2.7 – 4.2	–	14	–	μs
t <sub>OFF</sub>		Turn-OFF Time (Closed to Open) (Figures 8 and 9)		2.7 – 4.2	–	75	–	ns
T <sub>BBM</sub>		Break-Before-Make Time (Figure 7)			–	7.0	–	μs
BW	D+ to COM+ D- to COM-	-3 dB Bandwidth (Figure 10)	C <sub>L</sub> = 5 pF R <sub>S</sub> = 50 Ω		–	900	–	MHz

**ISOLATION** (Typical: T = 25°C, V<sub>CC</sub> = 3.3 V, R<sub>L</sub> = 50 Ω, C<sub>L</sub> = 5 pF)

Symbol	Pins	Parameter	Test Conditions	V <sub>CC</sub> (V)	-40°C to +85°C			Unit
					Min	Typ	Max	
O <sub>IRR</sub>	Open	OFF-Isolation (Figure 10)	f = 100 kHz, R <sub>S</sub> = 50 Ω		–	-81	–	dB
X <sub>TALK</sub>	COM+ to COM-	Non-Adjacent Channel Crosstalk (Figure 10)	f = 100 kHz, R <sub>S</sub> = 50 Ω		–	-93	–	dB
THD+N		Total Harmonic Distortion + Noise	V <sub>BUS_CTRL</sub> = 0 V A <sub>SEL</sub> = 3.0 V f = 20 Hz to 20 kHz V <sub>COM</sub> = 0.5 V <sub>pp</sub> R <sub>L</sub> = 600 Ω	3.0	–	0.001	–	%
THD		Total Harmonic Distortion	V <sub>BUS_CTRL</sub> = 0 V A <sub>SEL</sub> = 0 V, 3.6 V f = 1 kHz V <sub>COM</sub> = ±2.0 V <sub>pp</sub> R <sub>L</sub> = 16 Ω	3.6	–	0.01	–	%
PSRR		Power Supply Rejection Ratio	f = 10 kHz R <sub>COM</sub> = 50 Ω	3.0	–	60	–	dB

**CAPACITANCE** (Typical: T = 25°C, V<sub>CC</sub> = 3.3 V, R<sub>L</sub> = 50 Ω, C<sub>L</sub> = 5 pF, f = 1 MHz, A<sub>SEL</sub> = 0 V)

Symbol	Pins	Parameter	Test Conditions	-40°C to +85°C			Unit
				Min	Typ	Max	
C <sub>IN</sub>	A <sub>SEL</sub>	Control Pin Input Capacitance	V <sub>CC</sub> = 0 V	–	2.6	–	pF
C <sub>ON</sub>	D+ to COM+ D- to COM-	USB ON Capacitance	V <sub>BUS_CTRL</sub> = 5 V	–	6.9	–	pF
C <sub>ON</sub>	R to COM+ L to COM-	Audio ON Capacitance	V <sub>BUS_CTRL</sub> = 0 V	–	9.3	–	pF
C <sub>OFF</sub>	D+, D-	USB OFF Capacitance	V <sub>BUS_CTRL</sub> = 0 V	–	4.8	–	pF
C <sub>OFF</sub>	R, L	Audio OFF Capacitance	V <sub>BUS_CTRL</sub> = 5 V	–	4.8	–	pF

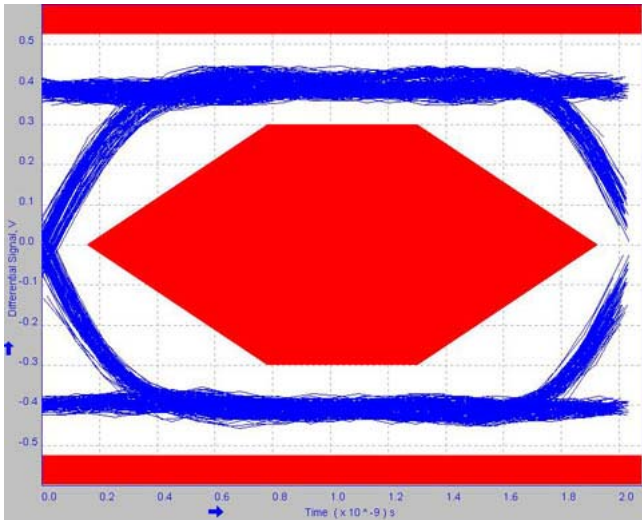


Figure 3. High Speed USB Eye Diagram of Signal Path without Switch

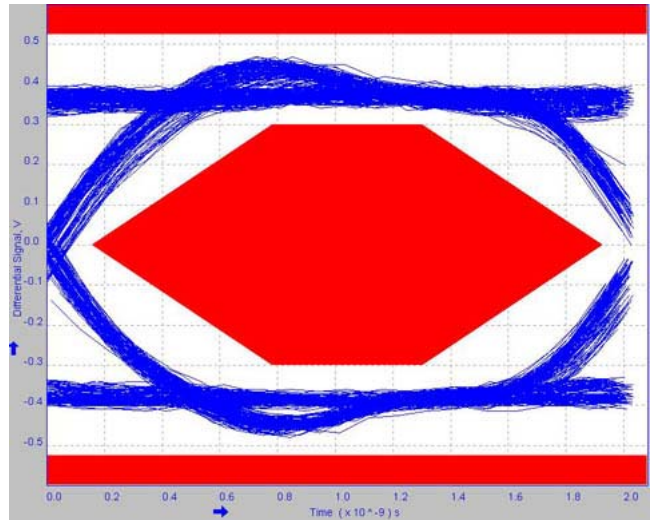


Figure 4. High Speed USB Eye Diagram of Signal Path with NS5S1153 ( $V_{CC} = 3.6 V$ )

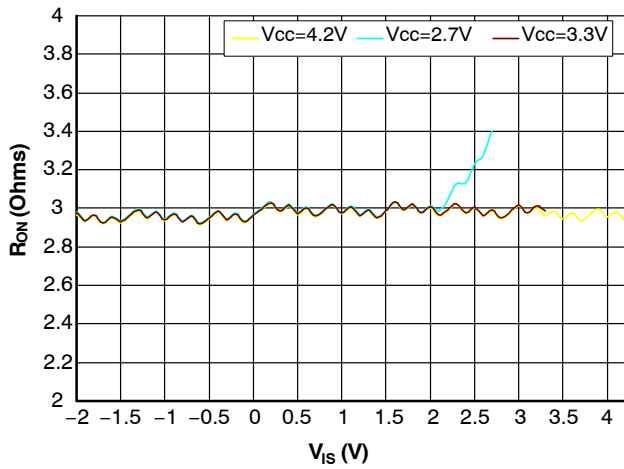


Figure 5. Audio ON Resistance vs. Signal Voltage @  $T = 25^{\circ}C$ ,  $2.7 V \leq V_{CC} \leq 4.2 V$

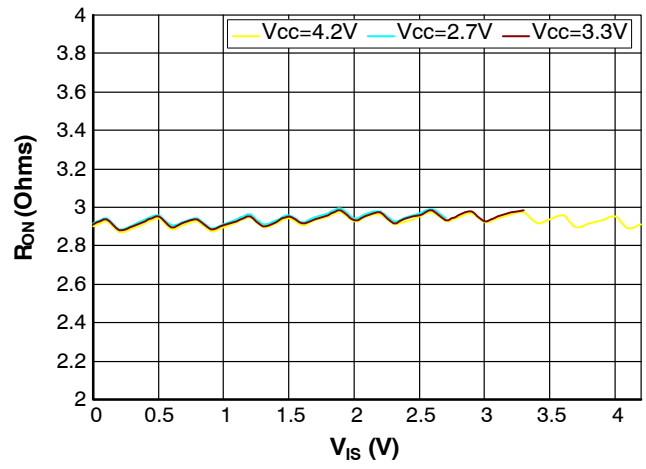


Figure 6. USB ON Resistance vs. Signal Voltage @  $T = 25^{\circ}C$ ,  $2.7 V \leq V_{CC} \leq 4.2 V$

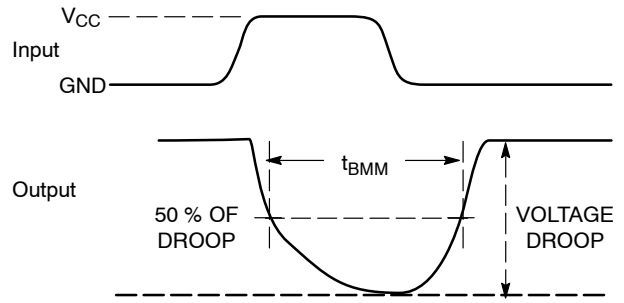
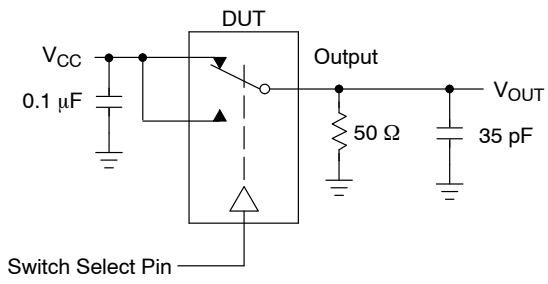


Figure 7.  $t_{BMM}$  (Time Break-Before-Make)

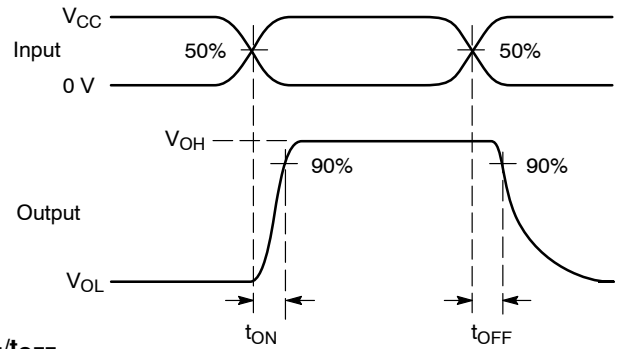
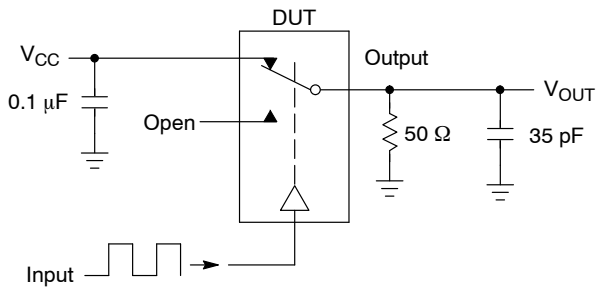


Figure 8.  $t_{ON}/t_{OFF}$

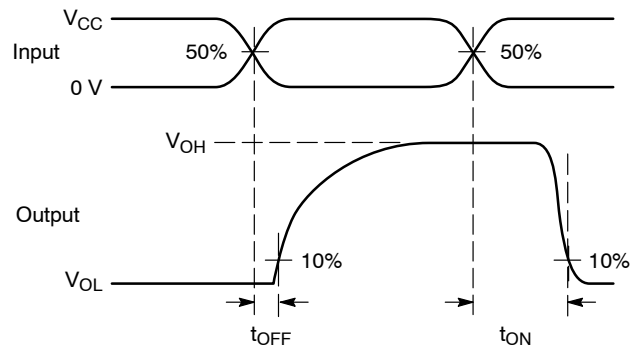
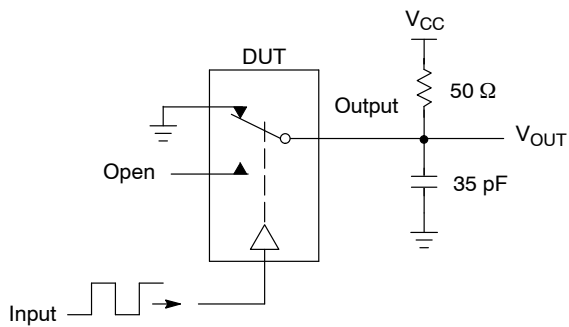
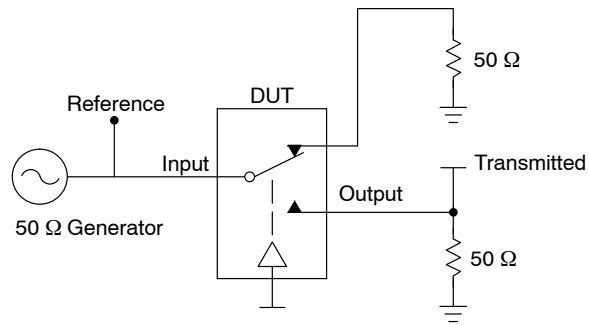


Figure 9.  $t_{ON}/t_{OFF}$

## NS5S1153



Channel switch control/s test socket is normalized. Off isolation is measured across an off channel. On loss is the bandwidth of an On switch.  $V_{ISO}$ , Bandwidth and  $V_{ONL}$  are independent of the input signal direction.

$$V_{ISO} = \text{Off Channel Isolation} = 20 \text{ Log} \left( \frac{V_{OUT}}{V_{IN}} \right) \text{ for } V_{IN} \text{ at } 100 \text{ kHz}$$

$$V_{ONL} = \text{On Channel Loss} = 20 \text{ Log} \left( \frac{V_{OUT}}{V_{IN}} \right) \text{ for } V_{IN} \text{ at } 100 \text{ kHz to } 50 \text{ MHz}$$

Bandwidth (BW) = the frequency 3 dB below  $V_{ONL}$

$V_{CT}$  = Use  $V_{ISO}$  setup and test to all other switch analog input/outputs terminated with 50  $\Omega$

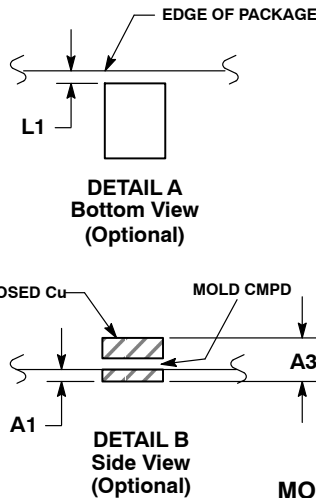
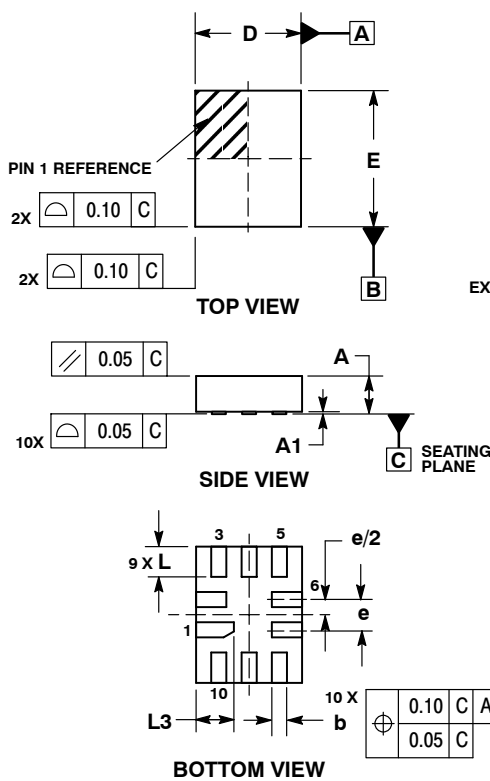
**Figure 10. Off Channel Isolation/On Channel Loss (BW)/Crosstalk (On Channel to Off Channel)/ $V_{ONL}$**



# NS5S1153

## PACKAGE DIMENSIONS

UQFN10 1.4x1.8, 0.4P  
CASE 488AT-01  
ISSUE A

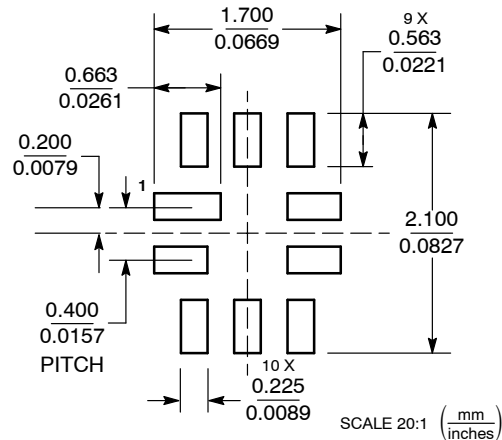


**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

DIM	MILLIMETERS	
	MIN	MAX
A	0.45	0.60
A1	0.00	0.05
A3	0.127	REF
b	0.15	0.25
D	1.40	BSC
E	1.80	BSC
e	0.40	BSC
L	0.30	0.50
L1	0.00	0.15
L3	0.40	0.60

**MOUNTING FOOTPRINT**



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
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- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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